



DMS3016SSSA

N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Product Summary

BV _{DSS}	R _{DS(ON)} MAX	I _D MAX T _A = +25°C
	$13m\Omega$ @ $V_{GS} = 10V$	8.9A
30V	16mΩ @ V _{GS} = 4.5V	8.0A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

Features

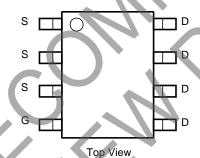
- DIOFET Utilizes a Unique Patented Process to Monolithically Integrate a MOSFET and a Schottky in a Single Die to Deliver:
 - Low R_{DS(ON)} Minimizes Conduction Losses
 - Ultra Low V_{SD} Reduce Losses due to Body Diode Conduction
 - Low Q_{rr} Lower Q_{rr} of the Integrated Schottky Reduces Body Diode Switching Losses
 - Low Gate Capacitance (Q_g/Q_{gs}) Ratio Reduces Risk of Shoot-Through or Cross Conduction Currents at High Frequencies
 - Avalanche Rugged I_{AR} and E_{AR} Rated
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

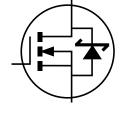
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
 - Weight: 0.074 grams (Approximate)



Top View



Internal Schematic



Equivalent circuit

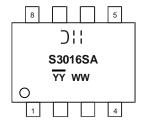
Ordering Information (Note 4)

Part Number	Case	Packaging
DMS3016SSSA-13	SO-8	2500 / Tape & Reel

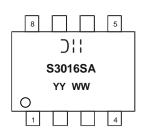
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - B. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Chengdu A/T Site



Shanghai A/T Site

⊃¦¦ = Manufacturer's Marking S3016SA = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 18 = 2018) WW = Week (01 to 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test Site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test Site)



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Character	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	I _D	8.0 5.8	А
Pulsed Drain Current (Note 6)	I _{DM}	90	Α		
Avalanche Current (Notes 6 & 7)	I _{AR}	13	Α		
Repetitive Avalanche Energy (Notes 6 & 7) L =	E _{AR}	25.4	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.54	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	R _{0JA}	81	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

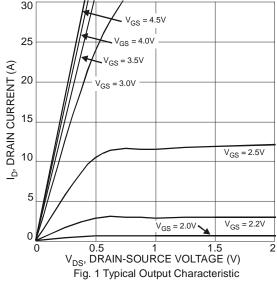
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	IAIMI	1 4 1	IVIGA	Oint	rest condition	
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	K-7	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	<u>1</u>		1.0	mA	V _{DS} = 30V, V _{GS} = 0V	
Gate-Source Leakage	IGSS	_		±100	nA	$V_{GS} = \pm 12V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)	333	•				, 50	
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	9	13	mΩ	V _{GS} = 10V, I _D = 9.8A	
Static Drain-Source On-Resistance	R _{DS(ON)}	A	11	16	11177	$V_{GS} = 4.5V, I_D = 9.8A$	
Forward Transfer Admittance	Y _{fs}		11	-	S	$V_{DS} = 5V, I_{D} = 9.8A$	
Diode Forward Voltage	V _{SD}	77	0.35	0.6	V	$V_{GS} = 0V, I_{S} = 1A$	
Maximum Body-Diode + Schottky Continuous Current	Is		_	5	Α	-	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	1849	_	рF	15)/)/ 0)/	
Output Capacitance	Coss	_	158	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	123	_	pF	1 = 1.000112	
Gate Resistance	R_g	0.53	2.68	4.82	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge V _{GS} = 4.5V	Q_g	_	18.5		nC		
Total Gate Charge V _{GS} = 10V	Q_g	_	43	_	nC	$V_{DS} = 15V, V_{GS} = 10V,$ $I_{D} = 9.8A$	
Gate-Source Charge	Qgs	_	4.7	_	nC		
Gate-Drain Charge	Q_{gd}	_	4.0	_	nC		
Turn-On Delay Time	t _{D(on)}	_	6.62	_	ns		
Turn-On Rise Time	t _r		8.73	_	ns	$V_{GS} = 10V, V_{DS} = 10V,$	
Turn-Off Delay Time	t _{D(off)}	_	36.41	_	ns	$R_g = 3\Omega$, $R_L = 1.2\Omega$	
Turn-Off Fall Time	t _f		4.69		ns]	

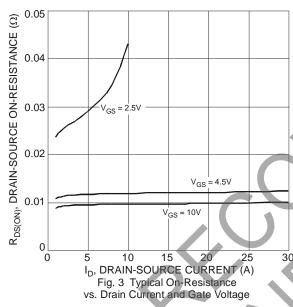
Notes:

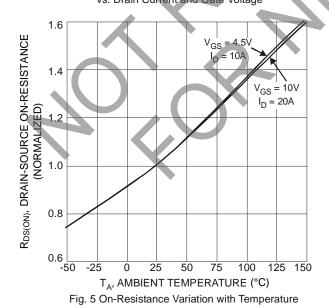
- 5. Device mounted on minimum recommended layout. The value in any given application depends on the user's specific board design. 6. Repetitive rating, pulse width limited by junction temperature.
- 7. I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep $T_{J} = +25$ °C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

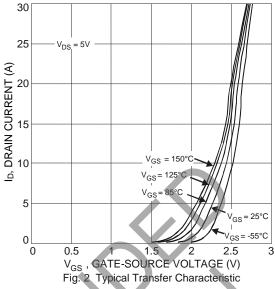


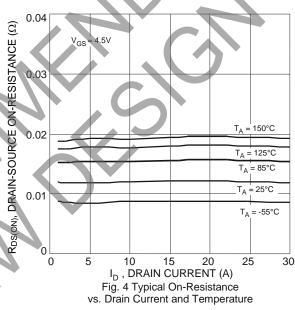
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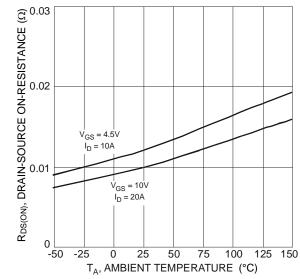


Fig. 6 On-Resistance Variation with Temperature



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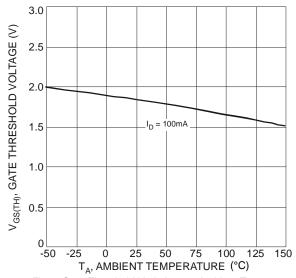
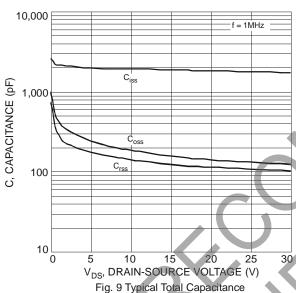
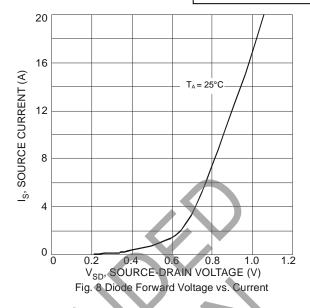
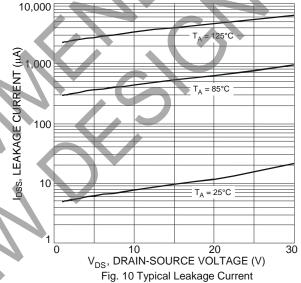


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



8 | V_{DS} = 15V | I_D = 12.7A | V_{DS} = 12.7A | V



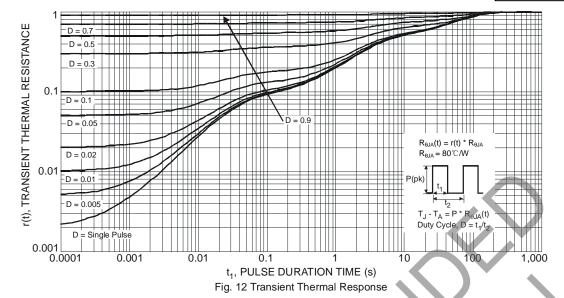


vs. Drain-Source Voltage

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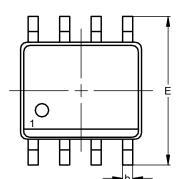


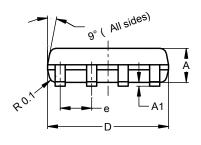
SO-8

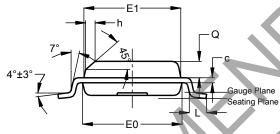


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



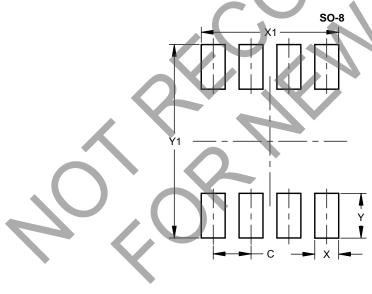




SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
ਰ	0.30	0.50	0.40			
C	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е	1		1.27			
h	-		0.35			
T	0.62	0.82	0.72			
ρ	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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